

SN74LVCH16543A

16-BIT REGISTERED TRANSCEIVER WITH 3-STATE OUTPUTS

SCAS317D – NOVEMBER 1993 – REVISED JULY 1997

- Member of the Texas Instruments *Widebus*™ Family
- *EPIC*™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Power Off Disables Inputs/Outputs, Permitting Live Insertion
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

description

This 16-bit registered transceiver is designed for 2.7-V to 3.6-V V_{CC} operation.

The SN74LVCH16543A can be used as two 8-bit transceivers or one 16-bit transceiver. Separate latch-enable (\overline{LEAB} or \overline{LEBA}) and output-enable (\overline{OEAB} or \overline{OEBA}) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (\overline{CEAB}) input must be low to enter data from A or to output data from B. If \overline{CEAB} is low and \overline{LEAB} is low, the A-to-B latches are transparent; a subsequent low-to-high transition of \overline{LEAB} puts the A latches in the storage mode. With \overline{CEAB} and \overline{OEAB} both low, the 3-state B outputs are active and reflect the data present at the output of the A latches. Data flow from B to A is similar, but requires using the \overline{CEBA} , \overline{LEBA} , and \overline{OEBA} inputs.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

DGG OR DL PACKAGE
(TOP VIEW)

$\overline{1OEAB}$	1	56	$\overline{1OEBA}$
$\overline{1LEAB}$	2	55	$\overline{1LEBA}$
$\overline{1CEAB}$	3	54	$\overline{1CEBA}$
GND	4	53	GND
1A1	5	52	1B1
1A2	6	51	1B2
V_{CC}	7	50	V_{CC}
1A3	8	49	1B3
1A4	9	48	1B4
1A5	10	47	1B5
GND	11	46	GND
1A6	12	45	1B6
1A7	13	44	1B7
1A8	14	43	1B8
2A1	15	42	2B1
2A2	16	41	2B2
2A3	17	40	2B3
GND	18	39	GND
2A4	19	38	2B4
2A5	20	37	2B5
2A6	21	36	2B6
V_{CC}	22	35	V_{CC}
2A7	23	34	2B7
2A8	24	33	2B8
GND	25	32	GND
$\overline{2CEAB}$	26	31	$\overline{2CEBA}$
$\overline{2LEAB}$	27	30	$\overline{2LEBA}$
$\overline{2OEAB}$	28	29	$\overline{2OEBA}$



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description (continued)

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74LVCH16543A is characterized for operation from -40°C to 85°C .

FUNCTION TABLE[†]
(each 8-bit section)

INPUTS				OUTPUT B
$\overline{\text{CEAB}}$	$\overline{\text{LEAB}}$	$\overline{\text{OEAB}}$	A	
H	X	X	X	Z
X	X	H	X	Z
L	H	L	X	B_0^{\ddagger}
L	L	L	L	L
L	L	L	H	H

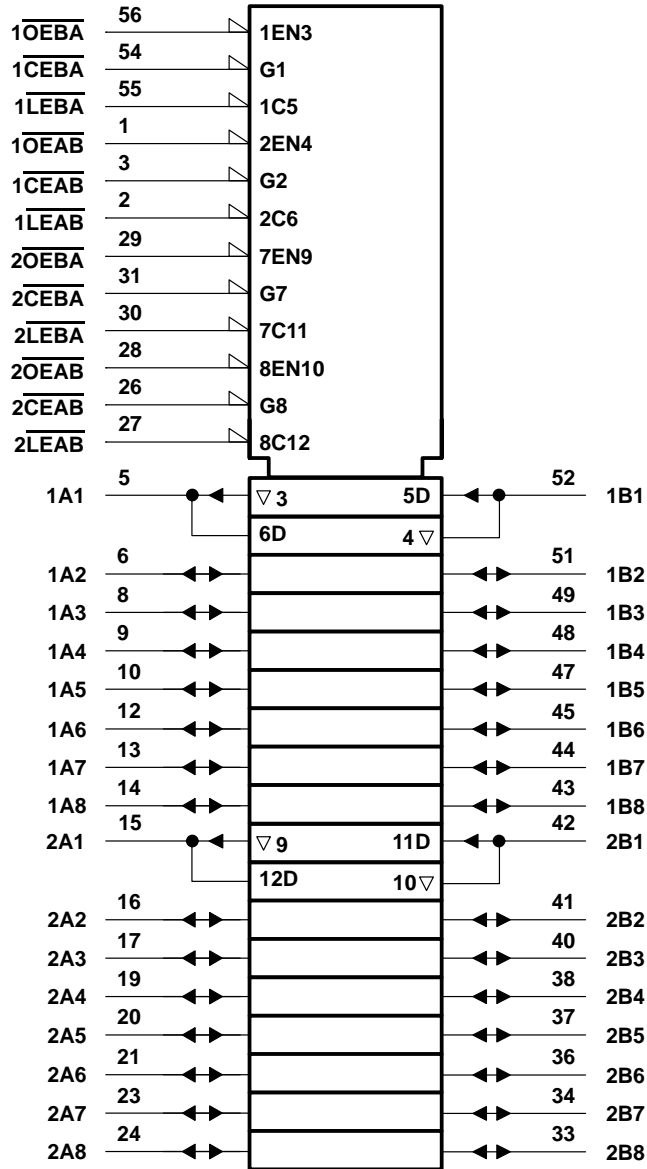
[†] A-to-B data flow is shown; B-to-A flow control is the same except that it uses $\overline{\text{CEBA}}$, $\overline{\text{LEBA}}$, and $\overline{\text{OEBA}}$.

[‡] Output level before the indicated steady-state input conditions were established

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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

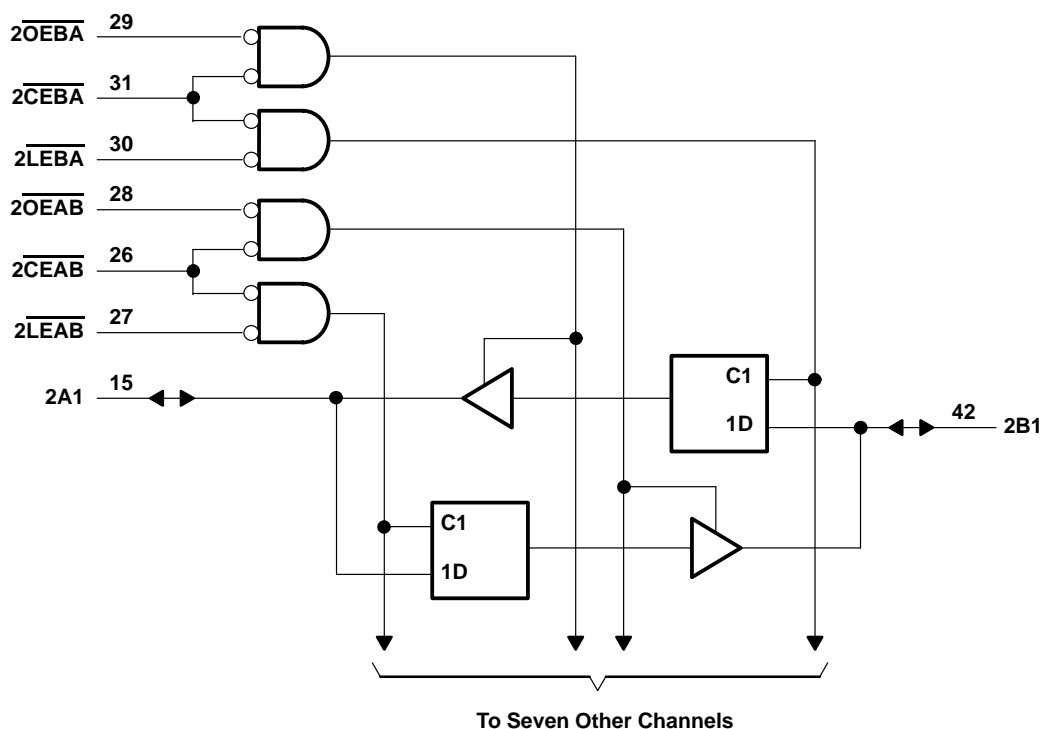
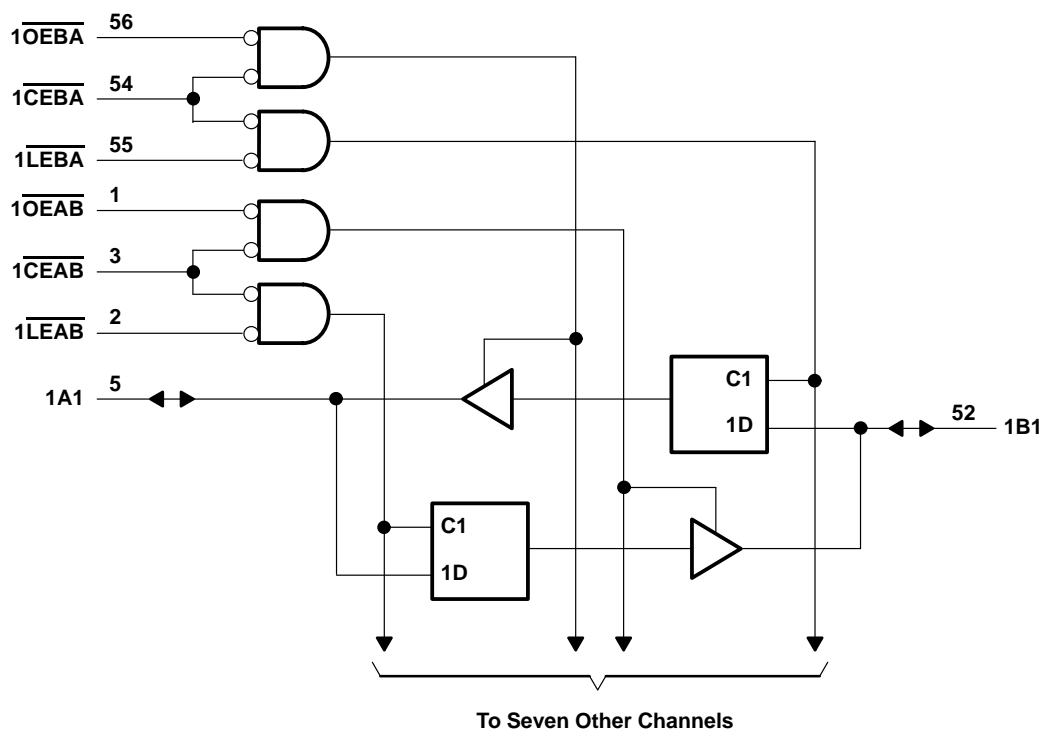
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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)§

Supply voltage range, V_{CC}	–0.5 V to 6.5 V
Input voltage range, V_I : Except I/O ports (see Note 1)	–0.5 V to 6.5 V
I/O ports (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC}) (see Note 2)	±50 mA
Continuous current through each V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

§ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The value of V_{CC} is provided in the recommended operating conditions table.
3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

		MIN	MAX	UNIT
V_{CC} Supply voltage	Operating	2	3.6	V
	Data retention only	1.5		
V_{IH} High-level input voltage	$V_{CC} = 2.7$ V to 3.6 V	2		V
V_{IL} Low-level input voltage	$V_{CC} = 2.7$ V to 3.6 V		0.8	V
V_I Input voltage		0	5.5	V
V_O Output voltage	High or low state	0	V_{CC}	V
	3 state	0	5.5	
I_{OH} High-level output current	$V_{CC} = 2.7$ V		–12	mA
	$V_{CC} = 3$ V		–24	
I_{OL} Low-level output current	$V_{CC} = 2.7$ V		12	mA
	$V_{CC} = 3$ V		24	
$\Delta t/\Delta V$ Input transition rise or fall rate		0	10	ns/V
T_A Operating free-air temperature		–40	85	°C

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	MIN	TYP†	MAX	UNIT
V _{OH}		I _{OH} = −100 μA	2.7 V to 3.6 V	V _{CC} −0.2			V
		I _{OH} = −12 mA	2.7 V	2.2			
			3 V	2.4			
		I _{OH} = −24 mA	3 V	2.2			
V _{OL}		I _{OL} = 100 μA	2.7 V to 3.6 V			0.2	V
		I _{OL} = 12 mA	2.7 V			0.4	
		I _{OL} = 24 mA	3 V			0.55	
I _I	Control inputs	V _I = 0 to 5.5 V	3.6 V			±5	μA
I _I (hold)	A or B ports	V _I = 0.8 V	3 V	75			μA
		V _I = 2 V	3 V	−75			
		V _I = 0 to 3.6 V‡	3.6 V	±500			
I _{off}		V _I or V _O = 5.5 V	0			±10	μA
I _{OZ} §		V _O = 0 to 5.5 V	3.6 V			±10	μA
I _{CC}		V _I = V _{CC} or GND	3.6 V			20	μA
		3.6 V ≤ V _I ≤ 5.5 V¶				20	
ΔI _{CC}		One input at V _{CC} − 0.6 V, Other inputs at V _{CC} or GND	2.7 V to 3.6 V			500	μA
C _i	Control inputs	V _I = V _{CC} or GND	3.3 V			5	pF
C _{io}	A or B ports	V _O = V _{CC} or GND	3.3 V			8	pF

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

§ For I/O ports, the parameter I_{OZ} includes the input leakage current, but not I_{I(hold)}.

¶ This applies in the disabled state only.

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V		UNIT
		MIN	MAX	MIN	MAX	
t _w	Pulse duration, $\overline{\text{LE}}$ or $\overline{\text{CE}}$ low	3.3		3.3		ns
t _{su}	Setup time, data before $\overline{\text{LE}}$ or $\overline{\text{CE}}$ ↓	1.1		1.1		ns
t _h	Hold time, data after $\overline{\text{LE}}$ or $\overline{\text{CE}}$ ↓	1.9		1.9		ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V		UNIT
			MIN	MAX	MIN	MAX	
t _{pd}	A or B	B or A	1.2	5.4	6.1		ns
	$\overline{\text{LE}}$	A or B	1.5	6.1	7.4		
t _{en}	$\overline{\text{CE}}$	A or B	1.2	6.6	7.9		ns
t _{dis}			1.5	6.6	7.1		
t _{en}	$\overline{\text{OE}}$	A or B	1	6.3	7.6		ns
t _{dis}			1.5	6.3	6.9		



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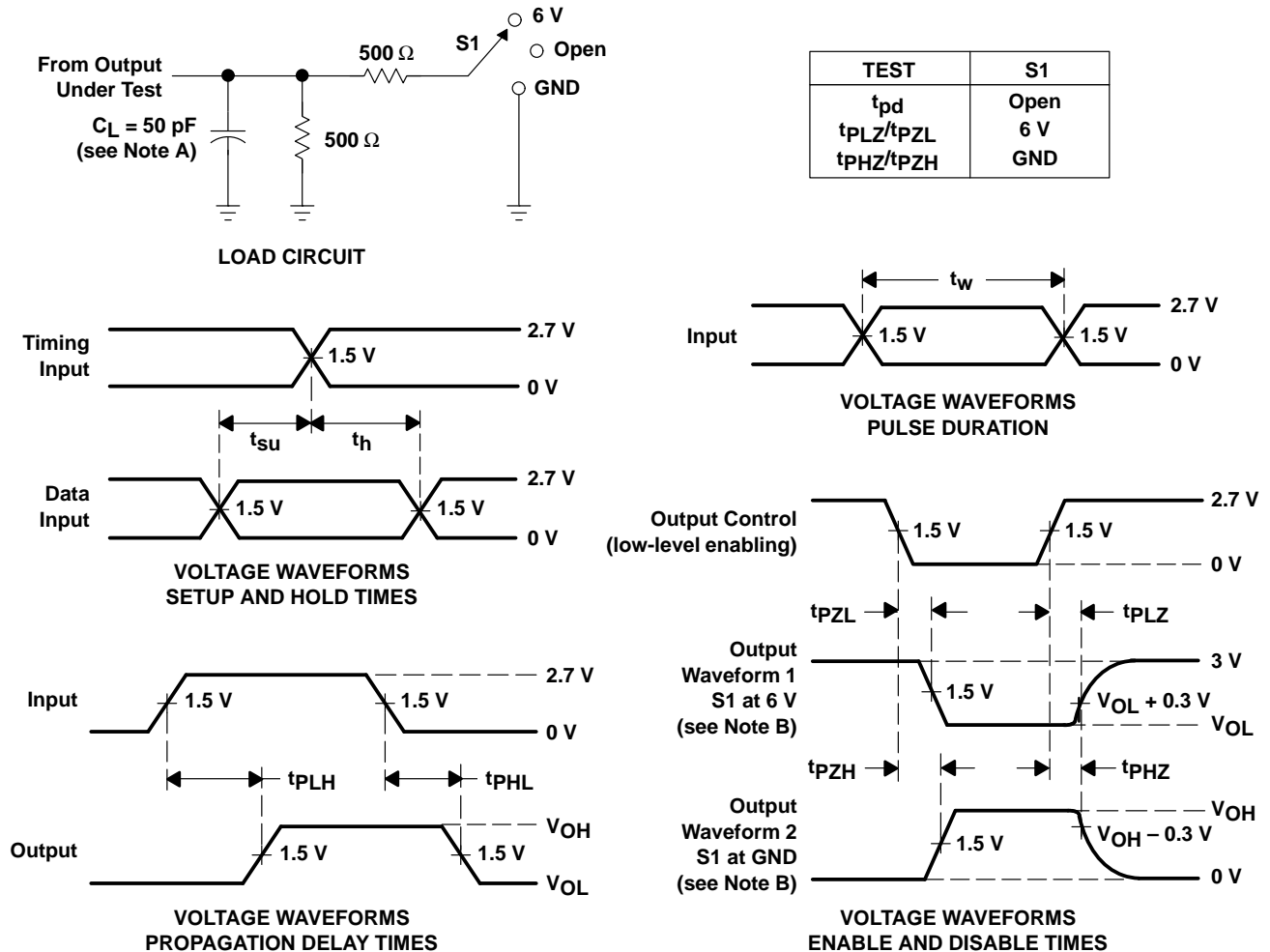
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operating characteristics, $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance per transceiver	Outputs enabled	44	pF
		Outputs disabled	4	

PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\text{ }\Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

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